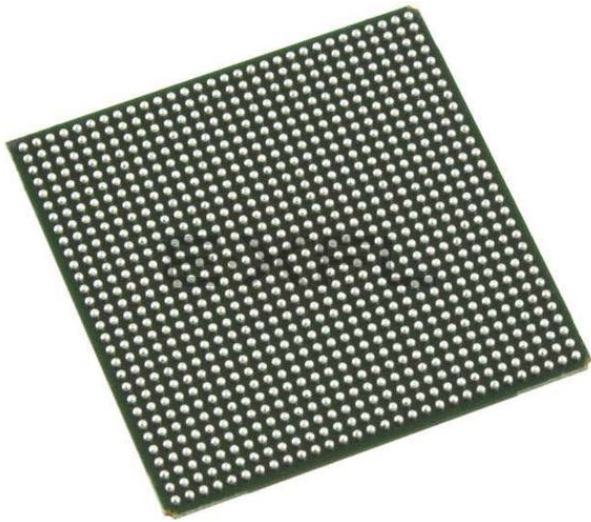




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	11875
Number of Logic Elements/Cells	95000
Total RAM Bits	5435392
Number of I/O	416
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100se-5f900i

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

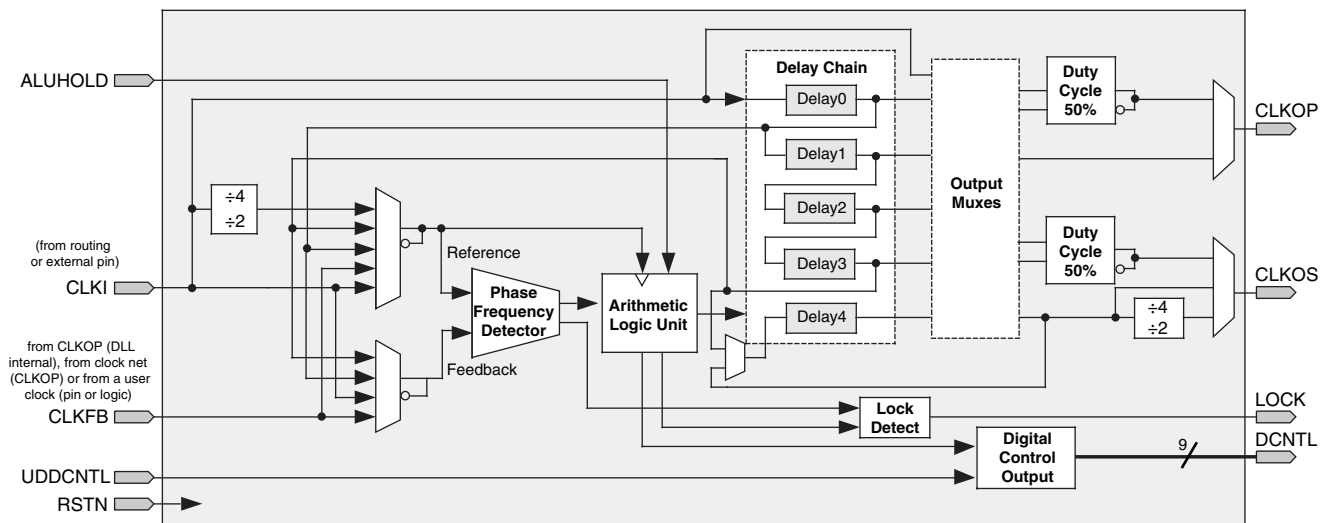
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

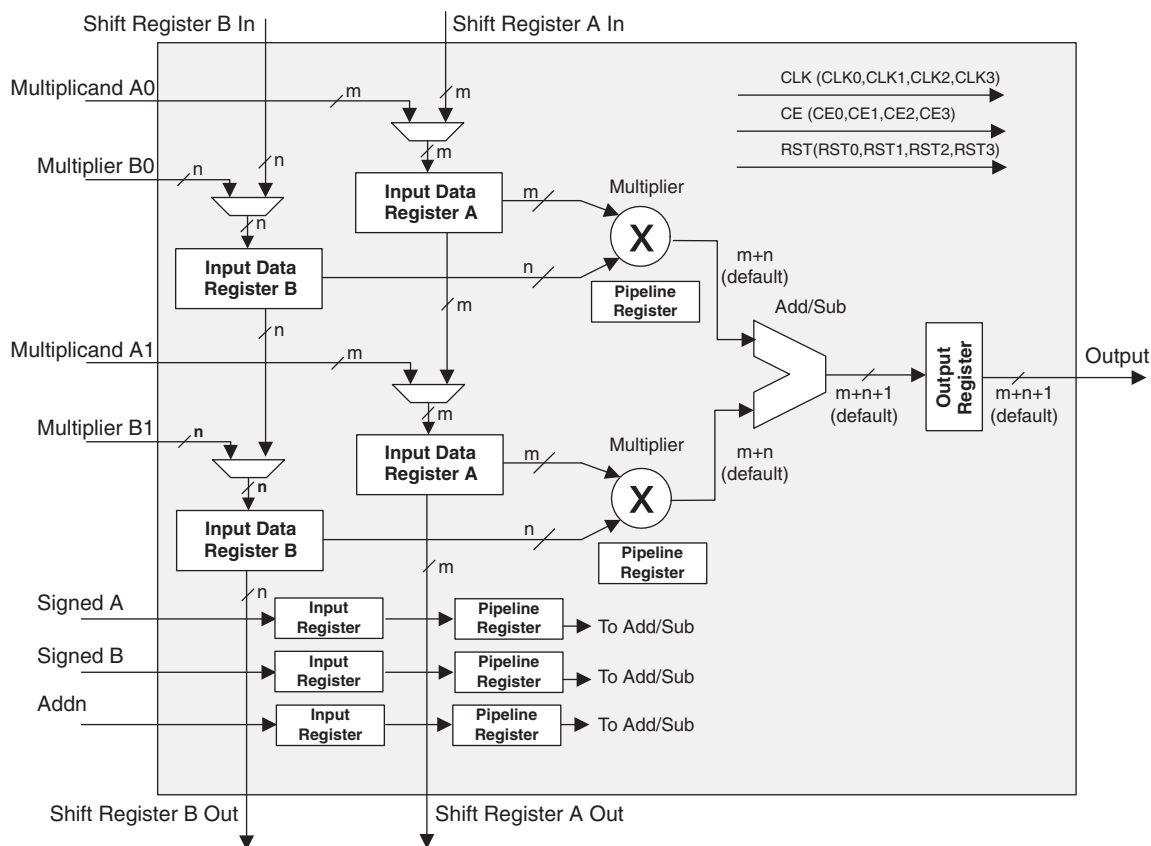
Figure 2-6. Delay Locked Loop Diagram (DLL)



MULTADDSUB sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-25 shows the MULTADDSUB sysDSP element.

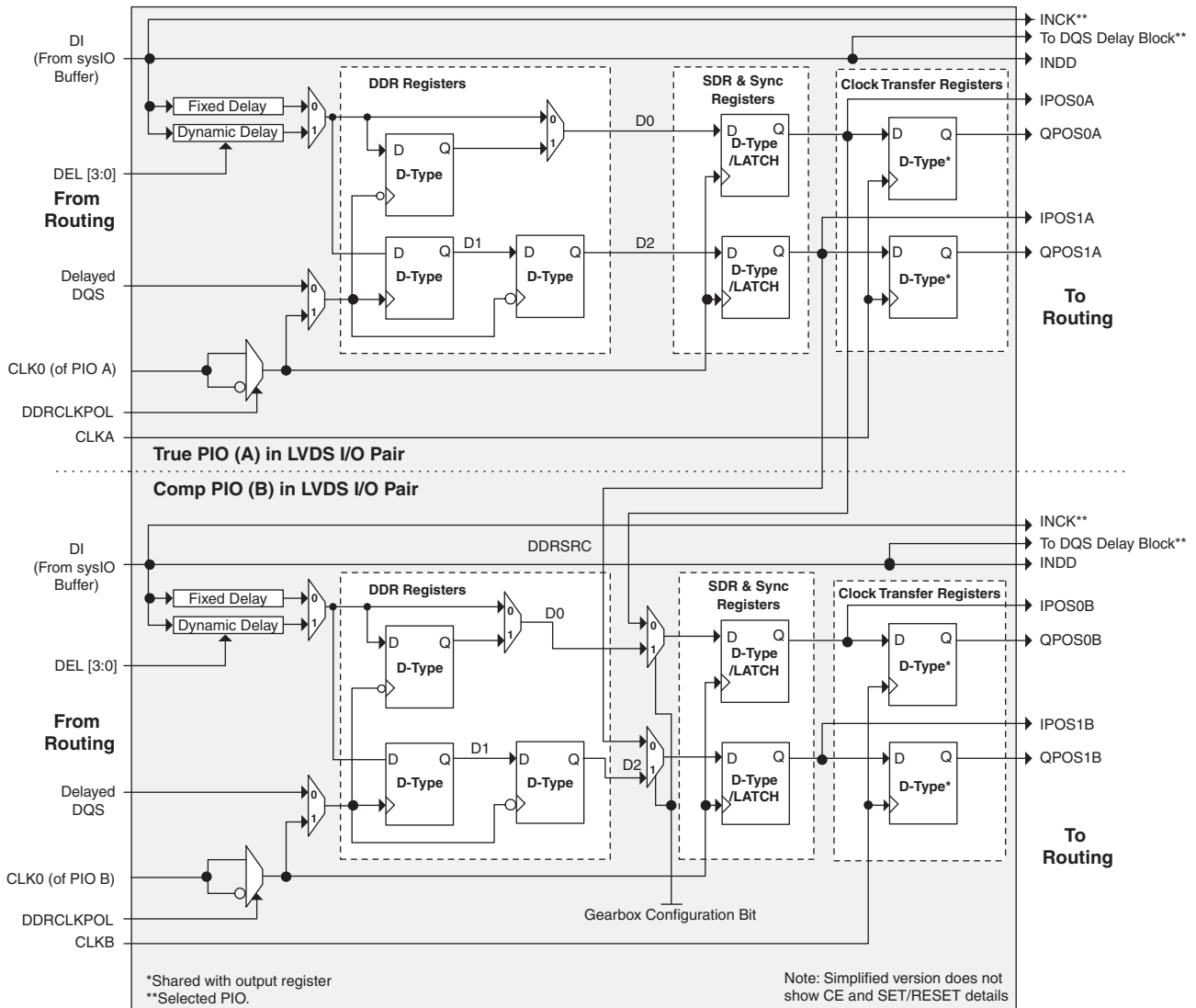
Figure 2-25. MULTADDSUB



By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

Figure 2-29. Input Register Block for Left, Right and Bottom Edges



SERDES and PCS (Physical Coding Sublayer)

LatticeECP2M devices feature up to 16 channels of embedded SERDES arranged in quads at the corners of the devices. Figure 2-39 shows the position of the quad blocks in relation to the PFU array for LatticeECP2M70 and LatticeECP2M100 devices. Table 2-15 shows the location of Quads for all the devices.

Each quad contains four dedicated SERDES (Ch0 to Ch3) for high-speed, full-duplex serial data transfer. Each quad also has a PCS block that interfaces to the SERDES channels and contains digital logic to support an array of popular data protocols. PCS also contains logic to the interface to FPGA core.

Figure 2-39. SERDES Quads (LatticeECP2M70/LatticeECP2M100)

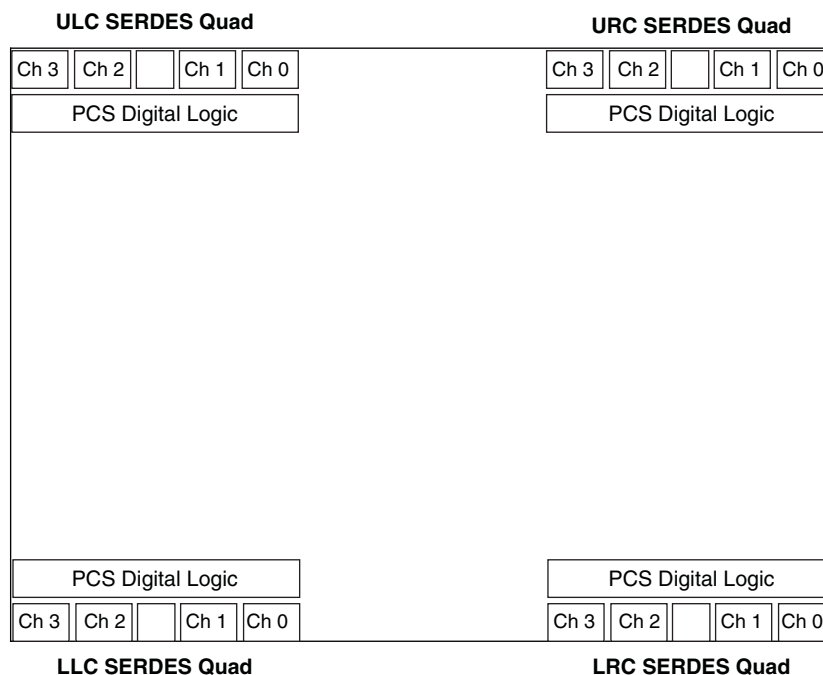


Table 2-15. Available SERDES Quads per LatticeECP2M Devices

Device	URC Quad	ULC Quad	LRC Quad	LLC Quad
ECP2M20	Available	—	—	—
ECP2M35	Available	—	—	—
ECP2M50	Available	—	Available	—
ECP2M70	Available	Available	Available	Available
ECP2M100	Available	Available	Available	Available

SERDES Block

A differential receiver receives the serial encoded data stream, equalizes the signal, extracts the buried clock and de-serializes the data-stream before passing the 8- or 10-bit data to the PCS logic. The transmit channel receives the parallel (8- or 10-bit) encoded data, serializes the data and transmits the serial bit stream through the differential buffers. There is a single transmit clock per quad. Figure 2-40 shows a single channel SERDES and its interface to the PCS logic. Each SERDES receiver channel provides a recovered clock to the PCS block and to the FPGA core logic.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP2/M devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant Test Access Port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP2/M devices contain two ports that can be used for device configuration. The Test Access Port (TAP), which supports bit-wide configuration, and the sysCONFIG port, support both byte-wide and serial configuration, including the standard SPI Flash interface. The TAP supports both the IEEE Standard 1149.1 Boundary Scan specification and the IEEE Standard 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six I/Os used as dedicated pins with the remainder used as dual-use pins. See TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#) for more information about using the dual-use pins as general purpose I/Os.

On power-up, the FPGA SRAM is ready to be configured using the selected sysCONFIG port. Once a configuration port is selected, it will remain active throughout that configuration cycle. The IEEE 1149.1 port can be activated any time after power-up by sending the appropriate command through the TAP port.

Enhanced Configuration Option

LatticeECP2/M devices have enhanced configuration features such as: decryption support, TransFR™ I/O and dual boot image support.

1. Decryption Support

LatticeECP2/M devices provide on-chip, One Time Programmable (OTP) non-volatile key storage to support decryption of a 128-bit AES encrypted bitstream, securing designs and deterring design piracy.

2. TransFR (Transparent Field Reconfiguration)

TransFR I/O (TFR) is a unique Lattice technology that allows users to update their logic in the field without interrupting system operation using a single ispVM® command. TransFR I/O allows I/O states to be frozen during device configuration. This allows the device to be field updated with a minimum of system disruption and downtime. See TN1087, [Minimizing System Interruption During Configuration Using TransFR Technology](#), for details.

3. Dual Boot Image Support

Dual boot images are supported for applications requiring reliable remote updates of configuration data for the system FPGA. After the system is running with a basic configuration, a new boot image can be downloaded remotely and stored in a separate location in the configuration storage device. Any time after the update the LatticeECP2/M can be re-booted from this new configuration file. If there is a problem, such as corrupt data during download or incorrect version number with this new boot image, the LatticeECP2/M device can revert back to the original backup configuration and try again. This all can be done without power cycling the system.

For more information about device configuration, please see the list of additional technical documentation at the end of this data sheet.

Soft Error Detect (SED) Support

LatticeECP2/M devices have dedicated logic to perform CRC checks. During configuration, the configuration data bitstream can be checked with the CRC logic block. In addition, the LatticeECP2 device can also be programmed

LatticeECP2 Initialization Supply Current^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ^{5, 6, 7}	Units
I_{CC}	Core Power Supply Current	ECP2-6	34	mA
		ECP2-12	54	mA
		ECP2-20	82	mA
		ECP2-35	135	mA
		ECP2-50	187	mA
		ECP2-70	267	mA
I_{CCAUx}	Auxiliary Power Supply Current	ECP2-6	30	mA
		ECP2-12	30	mA
		ECP2-20	30	mA
		ECP2-35	30	mA
		ECP2-50	30	mA
		ECP2-70	30	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.

2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

4. Frequency 0MHz.

5. $T_J = 25^{\circ}\text{C}$, power supplies at nominal voltage.

6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.

7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

Table 3-13. Periodic Receiver Jitter Tolerance Specification¹

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Periodic	3.125 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	2.5 Gbps	600 mV differential eye	—	—	0.22	UI, p-p
	1.25 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	250 Mbps ²	600 mV differential eye	—	—	0.08	UI, p-p

1. Values are measured with PRBS 2⁷-1, all channels operating.

2. Jitter specification is limited by measurement equipment capability.

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35 (Cont.)

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	1	2	2	2	3
	Bank3	0	0	0	2	0	2
	Bank4	0	2	3	3	3	3
	Bank5	0	1	3	4	3	4
	Bank6	0	1	2	3	1	3
	Bank7	0	1	2	2	2	3
	Bank8	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	0	0	0	0	0
	Bank3	0	0	0	0	0	0
	Bank4	19	32	46	50	46	54
	Bank5	18	17	46	68	46	68
	Bank6	0	0	0	0	0	0
	Bank7	0	0	0	0	0	0
	Bank8	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
184	GND	-			GND	-			
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
186	PT26B	0		C	PT36B	0		C	
187	PT26A	0		T	PT36A	0		T	
188	VCC	-			VCC	-			
189	PT20B	0		C	PT30B	0		C	
190	VCCAUX	-			VCCAUX	-			
191	PT20A	0		T	PT30A	0		T	
192	GND	-			GND	-			
193	PT18B	0		C	PT26B	0		C	
194	PT18A	0		T	PT26A	0		T	
195	VCCIO0	0			VCCIO0	0			
196	PT16B	0		C	PT20B	0		C	
197	PT16A	0		T	PT20A	0		T	
198	VCC	-			VCC	-			
199	PT12B	0		C	PT12B	0		C	
200	PT12A	0		T	PT12A	0		T	
201	GND	-			GND	-			
202	PT8B	0		C	PT8B	0		C	
203	PT8A	0		T	PT8A	0		T	
204	PT6B	0		C	PT6B	0		C	
205	PT6A	0		T	PT6A	0		T	
206	VCCIO0	0			VCCIO0	0			
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO6	-			GNDIO6	-		
L2	PL24A	6	LDQ28	T (LVDS)*	PL24A	6	LDQ28	T (LVDS)*
K2	PL25A	6	LDQ28	T	PL25A	6	LDQ28	T
L3	PL24B	6	LDQ28	C (LVDS)*	PL24B	6	LDQ28	C (LVDS)*
K1	PL25B	6	LDQ28	C	PL25B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
L4	PL26A	6	LDQ28	T (LVDS)*	PL26A	6	LDQ28	T (LVDS)*
L1	PL27A	6	LDQ28	T	PL27A	6	LDQ28	T
L5	PL26B	6	LDQ28	C (LVDS)*	PL26B	6	LDQ28	C (LVDS)*
M1	PL27B	6	LDQ28	C	PL27B	6	LDQ28	C
GND	GNDIO6	-			GNDIO6	-		
N1	PL29A	6	LDQ28	T	PL29A	6	LDQ28	T
N2	PL28A	6	LDQS28	T (LVDS)*	PL28A	6	LDQS28	T (LVDS)*
P1	PL29B	6	LDQ28	C	PL29B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
P2	PL28B	6	LDQ28	C (LVDS)*	PL28B	6	LDQ28	C (LVDS)*
R1	PL30A	6	LDQ28	T (LVDS)*	PL30A	6	LDQ28	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
R2	PL30B	6	LDQ28	C (LVDS)*	PL30B	6	LDQ28	C (LVDS)*
N4	TDI	-			TDI	-		
M4	TCK	-			TCK	-		
P3	TDO	-			TDO	-		
N3	TMS	-			TMS	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
K6	NC	-			PB3A	5	BDQ6	
M6	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
R3	NC	-			PB5A	5	BDQ6	T
P4	NC	-			PB5B	5	BDQ6	C
-	-	-			VCCIO	5		
-	-	-			GNDIO5	5		
N5	PB3A	5	BDQ6	T	PB21A	5	BDQ24	T
N6	PB3B	5	BDQ6	C	PB21B	5	BDQ24	C
T2	PB4A	5	BDQ6	T	PB22A	5	BDQ24	T
P6	PB5A	5	BDQ6	T	PB23A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB4B	5	BDQ6	C	PB22B	5	BDQ24	C
R6	PB5B	5	BDQ6	C	PB23B	5	BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
R4	PB6A	5	BDQS6	T	PB24A	5	BDQS24	T
L6	PB7A	5	BDQ6	T	PB25A	5	BDQ24	T
T4	PB6B	5	BDQ6	C	PB24B	5	BDQ24	C
L7	PB7B	5	BDQ6	C	PB25B	5	BDQ24	C
N7	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO	VCCIO1	1		
D12	D12	PT62A	1		T
B14	B14	PT61B	1		C
C14	C14	PT60B	1		C
A14	A14	PT61A	1		T
D13	D13	PT60A	1		T
C13	C13	PT59B	1		C
GND	GND	GNDIO1	-		
A13	A13	PT58B	1		C
B13	B13	PT59A	1		T
VCCIO	VCCIO	VCCIO1	1		
A12	A12	PT58A	1		T
B11	B11	PT57B	1		C
D11	D11	PT56B	1		C
A11	A11	PT57A	1		T
C11	C11	PT56A	1		T
-	GND	GNDIO1	1		
-	VCC	VCCIO	1		
D10	D10	PT46B	1		C
C10	C10	PT46A	1		T
GND	GND	GNDIO1	-		
B10	B10	PT45B	1		C
A9	A9	PT44B	1		C
A10	A10	PT45A	1		T
B9	B9	PT44A	1		T
VCCIO	VCCIO	VCCIO1	1		
A8	A8	PT43B	1		C
D9	D9	PT42B	1		C
B8	B8	PT43A	1		T
C9	C9	PT42A	1		T
GND	GND	GNDIO1	-		
B7	B7	PT41B	1		C
E9	E9	PT40B	1		C
A7	A7	PT41A	1		T
D8	D8	PT40A	1		T
VCCIO	VCCIO	VCCIO1	1		
A6	A6	PT39B	1	PCLKC1_0	C
B6	B6	PT39A	1	PCLKT1_0	T
E6	E6	XRES	1		
F8	F8	PT37B	0	PCLKC0_0	C
GND	GND	GNDIO0	-		
E8	E8	PT37A	0	PCLKT0_0	T

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T7	PL29B	6	LDQ28	C	PL43B	6	LDQ42	C	
T6	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
AA2	PL31A	6	LDQ28	T	PL45A	6	LDQ42	T	
VCCIO	VCCIO6	6			VCCIO6	6			
Y1	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	
AA1	PL31B	6	LDQ28	C	PL45B	6	LDQ42	C	
W1	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*	
V3	PL30B	6	LDQ28	C (LVDS)*	PL44B	6	LDQ42	C (LVDS)*	
GNDIO	GNDIO6	-			GNDIO	-			
V4	PL30A	6	LDQ28	T (LVDS)*	PL44A	6	LDQ42	T (LVDS)*	
U5	TDI	-			TDI	-			
U7	TCK	-			TCK	-			
V6	TDO	-			TDO	-			
V5	TMS	-			TMS	-			
T8	VCCJ	-			VCCJ	-			
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
GNDIO	GNDIO5	-			GNDIO	-			
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
GNDIO	GNDIO5	-			GNDIO	-			
-	-	-			VCCIO5	5			
Y6	PB12A	5	BDQ15	T	PB21A	5	BDQ24	T	
W7	PB11A	5	BDQ15	T	PB20A	5	BDQ24	T	
Y7	PB12B	5	BDQ15	C	PB21B	5	BDQ24	C	
W8	PB11B	5	BDQ15	C	PB20B	5	BDQ24	C	
U8	PB14A	5	BDQ15	T	PB23A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AA7	PB13A	5	BDQ15	T	PB22A	5	BDQ24	T	
U9	PB14B	5	BDQ15	C	PB23B	5	BDQ24	C	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W19	CFG2	8			CFG2	8		
V19	CFG1	8			CFG1	8		
V20	PROGRAMN	8			PROGRAMN	8		
W20	CFG0	8			CFG0	8		
U22	PR28B	8	D1	C	PR42B	8	D1	C
V22	INITN	8			INITN	8		
R16	PR30B	8	WRITEN	C	PR44B	8	WRITEN	C
GNDIO	GNDIO8	-			GNDIO8	-		
W22	CCLK	8			CCLK	8		
R17	PR30A	8	CS1N	T	PR44A	8	CS1N	T
V21	DONE	8			DONE	8		
VCCIO	VCCIO8	8			VCCIO8	8		
U19	PR29B	8	CSN	C	PR43B	8	CSN	C
T17	PR26B	8	D5	C	PR40B	8	D5	C
U20	PR29A	8	D0/SPIFASTN	T	PR43A	8	D0/SPIFASTN	T
U21	PR28A	8	D2	T	PR42A	8	D2	T
GNDIO	GNDIO8	-			GNDIO8	-		
T18	PR26A	8	D6	T	PR40A	8	D6	T
T20	PR27B	8	D3	C	PR41B	8	D3	C
T21	PR25B	8	D7/SPID0	C	PR39B	8	D7/SPID0	C
T19	PR27A	8	D4	T	PR41A	8	D4	T
VCCIO	VCCIO8	8			VCCIO8	8		
T22	PR25A	8	DI/CSSPI0N	T	PR39A	8	DI/CSSPI0N	T
R18	PR24B	8	DOUT/CSON	C	PR38B	8	DOUT/CSON	C
R19	PR24A	8	BUSY/SISPI	T	PR38A	8	BUSY/SISPI	T
-	-	-			VCCIO3	3		
GNDIO	GNDIO3	-			GNDIO3	-		
P18	PR22B	3		C (LVDS)*	PR32B	3	RDQ34	C (LVDS)*
R22	PR23B	3		C	PR33B	3	RDQ34	C
P19	PR22A	3		T (LVDS)*	PR32A	3	RDQ34	T (LVDS)*
R21	PR23A	3		T	PR33A	3	RDQ34	T
VCCIO	VCCIO3	3			VCCIO3	3		
R20	PR21B	3	RLM0_GPLL_C_FB_A	C	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C
P22	PR21A	3	RLM0_GPLLT_FB_A	T	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T
P21	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*
N21	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*
N17	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
N22	PR18B	3	RLM0_GDLL_C_FB_A	C	PR28B	3	RLM0_GDLL_C_FB_A/RDQ25	C
M22	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR27B	3	RLM0_GDLL_C_IN_A**/RDQ25	C (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
N20	PR18A	3	RLM0_GDLLT_FB_A	T	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T
M21	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*
N19	NC	-			PR26B	3	RDQ25	C
-	-	-			VCCIO3	3		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U24	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	PR44B	3	RLM0_GPLL_C_IN_A**/RDQ48	C (LVDS)*	
U25	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	PR44A	3	RLM0_GPLL_T_IN_A**/RDQ48	T (LVDS)*	
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
P18	VCC	3			VCCPLL	3			
T19	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	PR42B	3	RLM0_GDLLC_FB_A/RDQ39	C	
U20	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	PR42A	3	RLM0_GDLLT_FB_A/RDQ39	T	
GND	GNDIO3	-			GNDIO3	-			
T25	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	PR41B	3	RLM0_GDLLC_IN_A**/RDQ39	C (LVDS)*	
T26	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	PR41A	3	RLM0_GDLLT_IN_A**/RDQ39	T (LVDS)*	
T20	PR26B	3	RDQ25	C	PR40B	3	RDQ39	C	
T22	PR26A	3	RDQ25	T	PR40A	3	RDQ39	T	
VCCIO	VCCIO3	3			VCCIO3	3			
R26	PR25B	3	RDQ25	C (LVDS)*	PR39B	3	RDQ39	C (LVDS)*	
R25	PR25A	3	RDQS25***	T (LVDS)*	PR39A	3	RDQS39***	T (LVDS)*	
R22	NC	-			PR38B	3	RDQ39	C	
GND	GNDIO3	-			GNDIO3	-			
T21	NC	-			PR38A	3	RDQ39	T	
P26	NC	-			NC	-			
P25	NC	-			NC	-			
R24	NC	-			NC	-			
VCCIO	VCCIO3	3			VCCIO3	3			
R23	NC	-			NC	-			
P20	NC	-			NC	-			
R19	NC	-			NC	-			
P21	NC	-			PR34B	3	RDQ31	C	
GND	GNDIO3	-			GNDIO3	-			
P19	NC	-			PR34A	3	RDQ31	T	
P23	NC	-			PR33B	3	RDQ31	C (LVDS)*	
P22	NC	-			PR33A	3	RDQ31	T (LVDS)*	
N22	NC	-			PR32B	3	RDQ31	C	
VCCIO	VCCIO3	3			VCCIO3	3			
R21	NC	-			PR32A	3	RDQ31	T	
N26	NC	-			PR31B	3	RDQ31	C (LVDS)*	
N25	NC	-			PR31A	3	RDQS31	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
N19	PR24B	3	RDQ25	C	PR30B	3	RDQ31	C	
N20	PR24A	3	RDQ25	T	PR30A	3	RDQ31	T	
M26	PR23B	3	RDQ25	C (LVDS)*	PR29B	3	RDQ31	C (LVDS)*	
M25	PR23A	3	RDQ25	T (LVDS)*	PR29A	3	RDQ31	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
N18	PR22B	3	VREF2_3/RDQ25	C	PR28B	3	VREF2_3/RDQ31	C	
N21	PR22A	3	VREF1_3/RDQ25	T	PR28A	3	VREF1_3/RDQ31	T	
L26	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	
L25	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	
N24	PR19B	2	PCLKC2_0/RDQ16	C	PR25B	2	PCLKC2_0/RDQ22	C	
M23	PR19A	2	PCLKT2_0/RDQ16	T	PR25A	2	PCLKT2_0/RDQ22	T	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ6	PB16A	5	BDQ15	T
AK6	PB16B	5	BDQ15	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AD10	PB29A	5	BDQ33	T
AF10	PB29B	5	BDQ33	C
AC11	PB30A	5	BDQ33	T
AD11	PB30B	5	BDQ33	C
AG9	PB31A	5	BDQ33	T
AH9	PB31B	5	BDQ33	C
VCCIO	VCCIO5	99		
AE11	PB32A	5	BDQ33	T
AG10	PB32B	5	BDQ33	C
GND	GNDIO5	-		
AJ9	PB33A	5	BDQS33	T
AK9	PB33B	5	BDQ33	C
AF11	PB34A	5	BDQ33	T
AH10	PB34B	5	BDQ33	C
AC12	PB35A	5	BDQ33	T
AE12	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5		
AD12	PB36A	5	BDQ33	T
AF12	PB36B	5	BDQ33	C
AJ10	PB37A	5	BDQ33	T
AK10	PB37B	5	BDQ33	C
GND	GNDIO5	-		
AG11	PB38A	5	BDQ42	T
AH11	PB38B	5	BDQ42	C
AE13	PB39A	5	BDQ42	T
AC13	PB39B	5	BDQ42	C
AF13	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5		
AD13	PB40B	5	BDQ42	C
AJ11	PB41A	5	BDQ42	T
AK11	PB41B	5	BDQ42	C
AD14	PB42A	5	BDQS42	T
GND	GNDIO5	-		
AC14	PB42B	5	BDQ42	C
AG12	PB43A	5	BDQ42	T
AE14	PB43B	5	BDQ42	C
AJ12	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5		
AK12	PB44B	5	BDQ42	C

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
E13	PT28B	1		C	PT46B	1		C	
D12	PT28A	1		T	PT46A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
A9	PT27B	1		C	PT45B	1		C	
A8	PT27A	1		T	PT45A	1		T	
A7	PT26B	1		C	PT44B	1		C	
A6	PT26A	1		T	PT44A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
E12	PT25B	1		C	PT43B	1		C	
F12	PT25A	1		T	PT43A	1		T	
A5	PT24B	1		C	PT42B	1		C	
A4	PT24A	1		T	PT42A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
B7	PT23B	1		C	PT41B	1		C	
B8	PT23A	1		T	PT41A	1		T	
G11	PT22B	1		C	PT40B	1		C	
E11	PT22A	1		T	PT40A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
D11	PT21B	1	VREF2_1	C	PT39B	1	VREF2_1	C	
D10	PT21A	1	VREF1_1	T	PT39A	1	VREF1_1	T	
F11	PT20A	1	PCLKT1_0	T	PT38A	1	PCLKT1_0	T	
G10	PT20B	1	PCLKC1_0	C	PT38B	1	PCLKC1_0	C	
G9	PT19B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
F9	PT19A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
C9	PT18B	0	VREF2_0	C	PT36B	0	VREF2_0	C	
D9	PT18A	0	VREF1_0	T	PT36A	0	VREF1_0	T	
A2	PT17B	0		C	PT35B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
A3	PT17A	0		T	PT35A	0		T	
B3	PT16B	0		C	PT34B	0		C	
C4	PT16A	0		T	PT34A	0		T	
E10	PT15B	0		C	PT33B	0		C	
F10	PT15A	0		T	PT33A	0		T	
C7	PT14B	0		C	PT32B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
B6	PT14A	0		T	PT32A	0		T	
C6	PT13B	0		C	PT31B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
C5	PT13A	0		T	PT31A	0		T	
C8	PT12B	0		C	PT30B	0		C	
D8	PT12A	0		T	PT30A	0		T	
E8	PT11B	0		C	PT29B	0		C	
E9	PT11A	0		T	PT29A	0		T	
-	-	-			GNDIO0	-			
-	-	-			VCCIO0	0			
F8	PT10B	0		C	PT10B	0		C	
G8	PT10A	0		T	PT10A	0		T	

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G19	GND	-			GND	-			
G4	GND	-			GND	-			
H10	GND	-			GND	-			
H13	GND	-			GND	-			
J14	GND	-			GND	-			
J9	GND	-			GND	-			
K10	GND	-			GND	-			
K11	GND	-			GND	-			
K12	GND	-			GND	-			
K13	GND	-			GND	-			
K15	GND	-			GND	-			
K20	GND	-			GND	-			
K3	GND	-			GND	-			
K8	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			
L12	GND	-			GND	-			
L13	GND	-			GND	-			
M10	GND	-			GND	-			
M11	GND	-			GND	-			
M12	GND	-			GND	-			
M13	GND	-			GND	-			
N10	GND	-			GND	-			
N11	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N15	GND	-			GND	-			
N20	GND	-			GND	-			
N3	GND	-			GND	-			
N8	GND	-			GND	-			
P14	GND	-			GND	-			
P9	GND	-			GND	-			
R10	GND	-			GND	-			
R13	GND	-			GND	-			
T19	GND	-			GND	-			
T4	GND	-			GND	-			
W16	GND	-			GND	-			
W2	GND	-			GND	-			
W21	GND	-			GND	-			
W7	GND	-			GND	-			
Y10	GND	-			GND	-			
Y13	GND	-			GND	-			
D15	NC	-			NC	-			
G14	NC	-			NC	-			
G15	NC	-			NC	-			
D14	NC	-			NC	-			
E15	NC	-			NC	-			
E14	NC	-			NC	-			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D23	NC	-			NC	-			
D24	NC	-			NC	-			
D25	NC	-			NC	-			
D26	NC	-			NC	-			
E20	NC	-			NC	-			
E21	NC	-			NC	-			
E25	NC	-			NC	-			
E26	NC	-			NC	-			
F20	NC	-			NC	-			
G20	NC	-			NC	-			
K10	NC	-			NC	-			
K17	NC	-			NC	-			
R4	NC	-			NC	-			
U10	NC	-			NC	-			
U23	NC	-			NC	-			
V10	NC	-			NC	-			
W7	NC	-			NC	-			
AB21	PB69B	4	BDQ69	C	NC	-			
AC20	PB58A	4	BDQ60	T	NC	-			
AC21	PB63A	4	BDQ60	T	NC	-			
AC22	PB69A	4	BDQS69****	T	NC	-			
AC23	PB71A	4	BDQ69	T	NC	-			
AC25	PB71B	4	BDQ69	C	NC	-			
AD26	PB70B	4	BDQ69	C	NC	-			
W20	PB72B	4	BDQ69	C	NC	-			
H7	L_VCCPLL	-			L_VCCPLL	-			
K6	L_VCCPLL	-			L_VCCPLL	-			
P7	L_VCCPLL	-			L_VCCPLL	-			
R8	L_VCCPLL	-			L_VCCPLL	-			
V18	R_VCCPLL	-			R_VCCPLL	-			
P20	R_VCCPLL	-			R_VCCPLL	-			
J17	R_VCCPLL	-			R_VCCPLL	-			
G19	R_VCCPLL	-			R_VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T	
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C	
GNDIO	GNDIO7	-			GNDIO7	-			
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
GNDIO	GNDIO7	-			-	-			
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
E2	PL14A	7		T	PL14A	7	LDQ15	T	
D1	PL14B	7		C	PL14B	7	LDQ15	C	
-	-	-			GNDIO7	-			
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*	
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*	
K7	NC	-			PL16A	7	LDQ15	T	
K8	NC	-			PL16B	7	LDQ15	C	
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*	
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*	
F1	NC	-			PL18A	7	LDQ15	T	
-	-	-			GNDIO7	-			
G3	NC	-			PL18B	7	LDQ15	C	
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*	
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*	
J5	PL16A	7		T	PL22A	7		T	
J4	PL16B	7		C	PL22B	7		C	
GNDIO	GNDIO7	-			GNDIO7	-			
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*	
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*	
L9	NC	-			PL25A	7	LDQ28	T	
L7	NC	-			PL25B	7	LDQ28	C	
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*	
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*	
L8	NC	-			PL27A	7	LDQ28	T	
L6	NC	-			PL27B	7	LDQ28	C	
-	-	-			GNDIO7	-			
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*	
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*	
N8	PL19A	7		T	PL29A	7	LDQ28	T	
M9	PL19B	7		C	PL29B	7	LDQ28	C	
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*	
VCCIO	VCCIO7	7			-	-			
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*	
H1	PL21A	7		T	PL31A	7	LDQ28	T	
GNDIO	GNDIO7	-			GNDIO7	-			
J1	PL21B	7		C	PL31B	7	LDQ28	C	
-	-	-			-	-			
-	-	-			-	-			

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100